

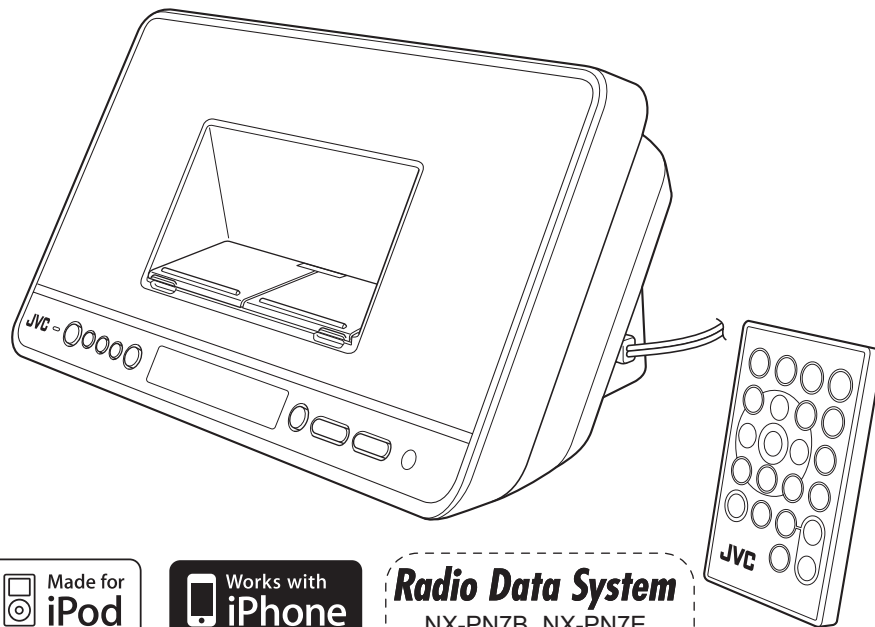
# JVC

## SCHEMATIC DIAGRAMS

### COMPACT COMPONENT SYSTEM

**NX-PN7J,NX-PN7C,NX-PN7B,NX-PN7E  
NX-PN7EN,NX-PN7EV,NX-PN7A,NX-PN7US  
NX-PN7UW,NX-PN7UJ**

DVD-ROM No.SML2008Q2



**Radio Data System**

NX-PN7B, NX-PN7E  
NX-PN7EN, NX-PN7EV

Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade)

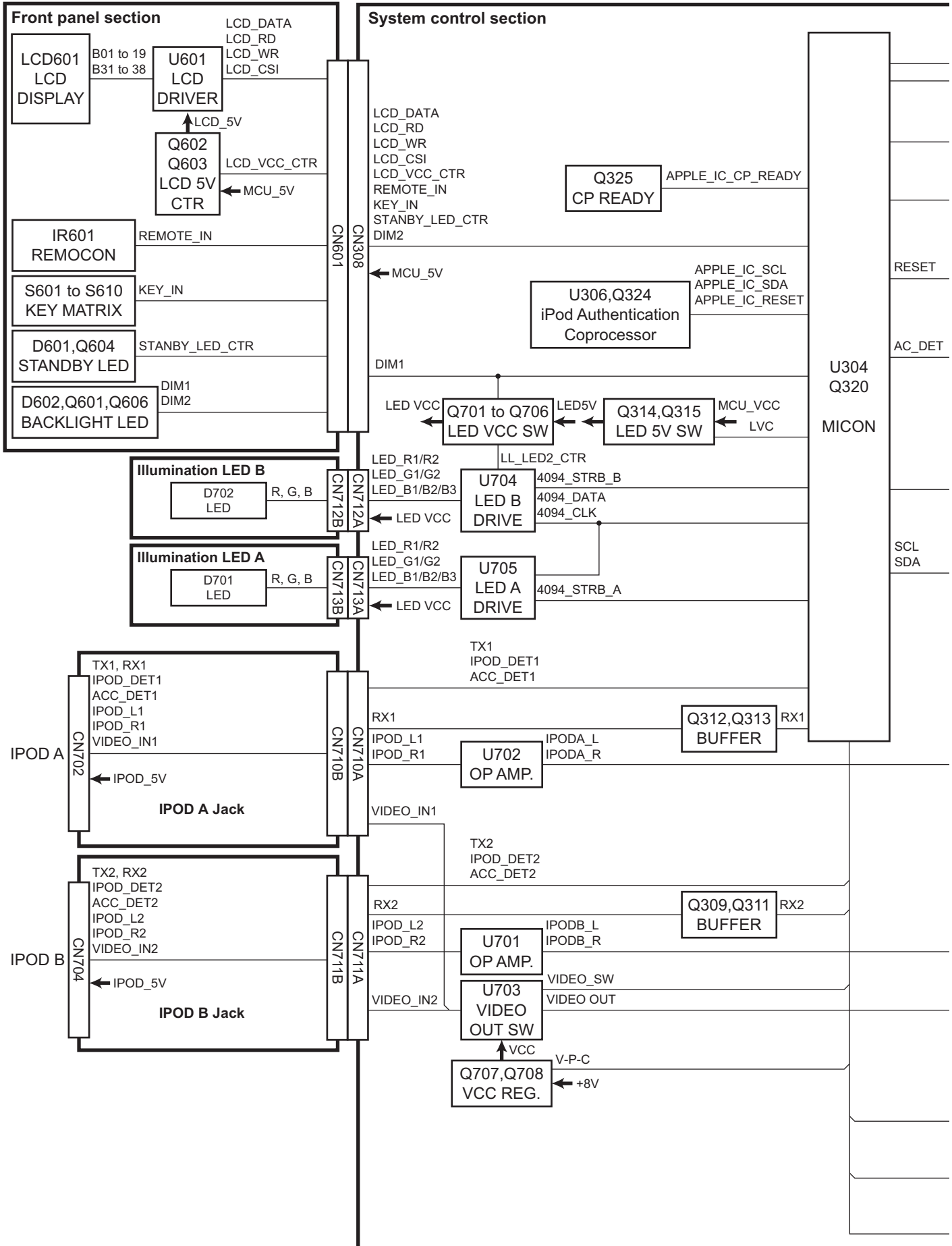
#### Contents

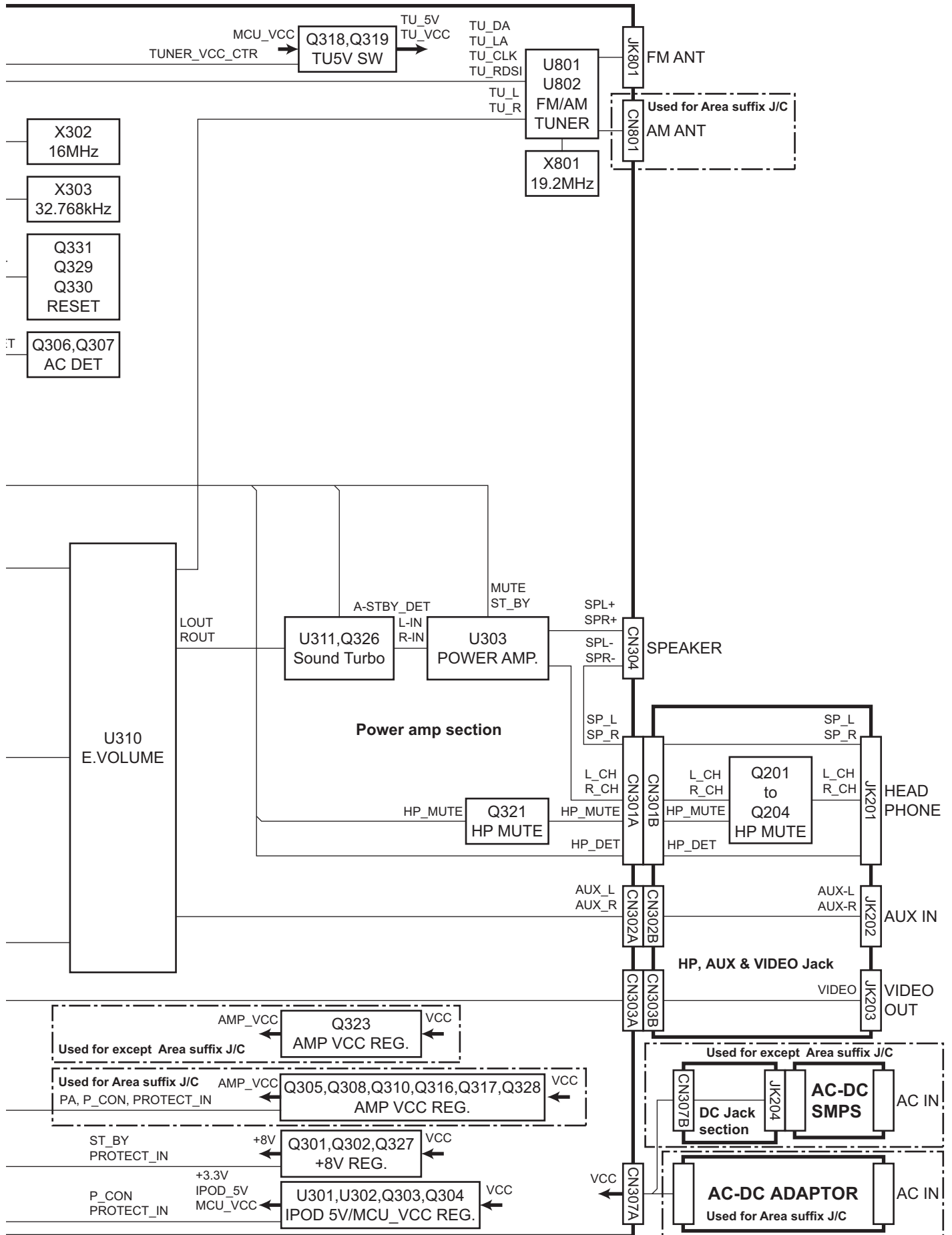
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In regard with component parts appearing on the silk-screen printed side (parts side) of the PWB diagrams, the parts that are printed over with black such as the resistor (■), diode (▣) and ICP (●) or identified by the "▲" mark nearby are critical for safety.

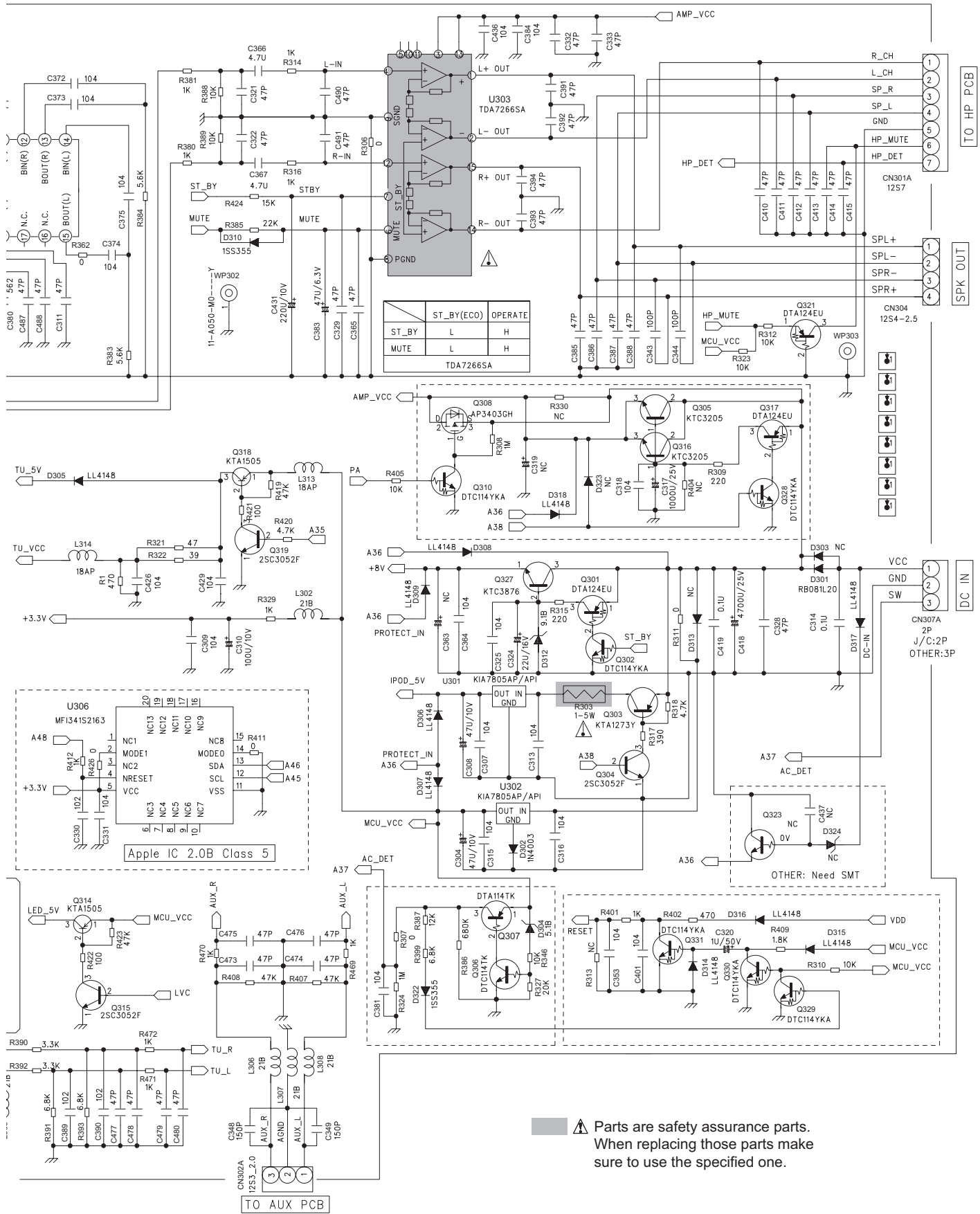
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# Block diagram





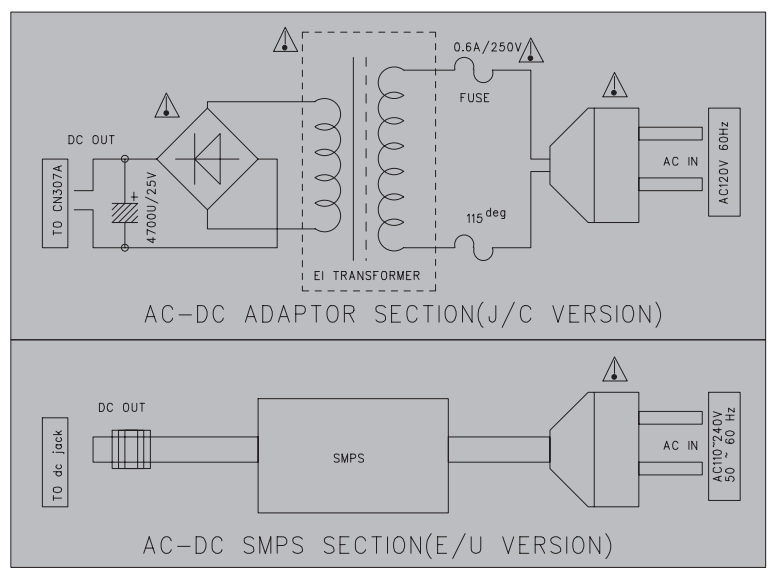
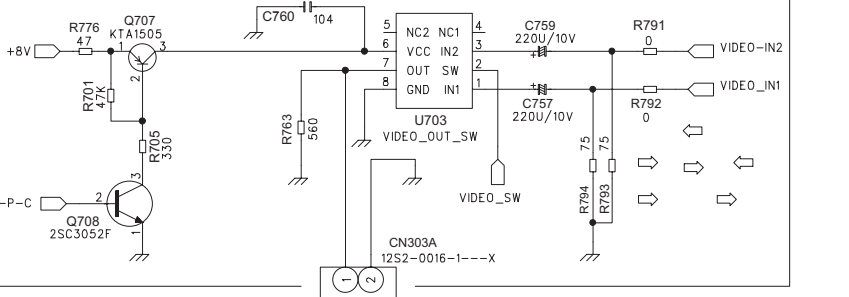
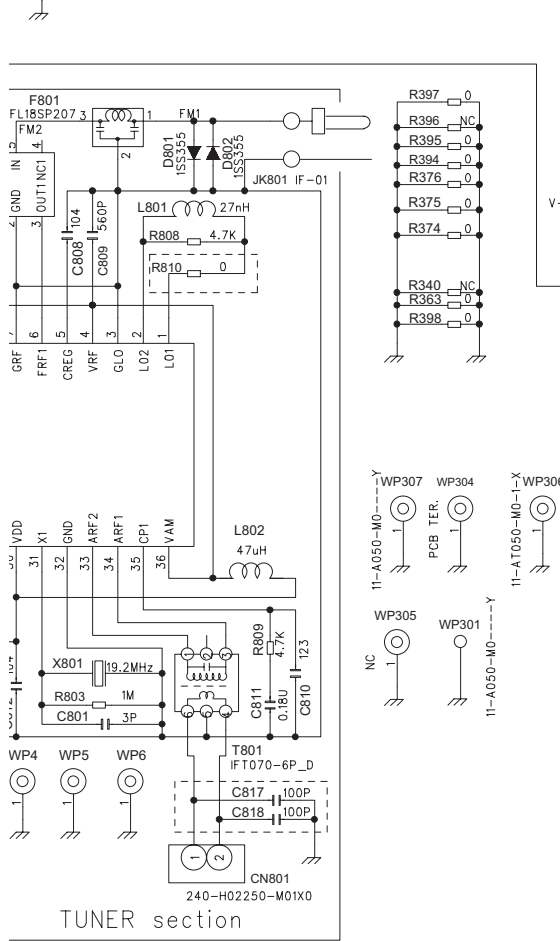
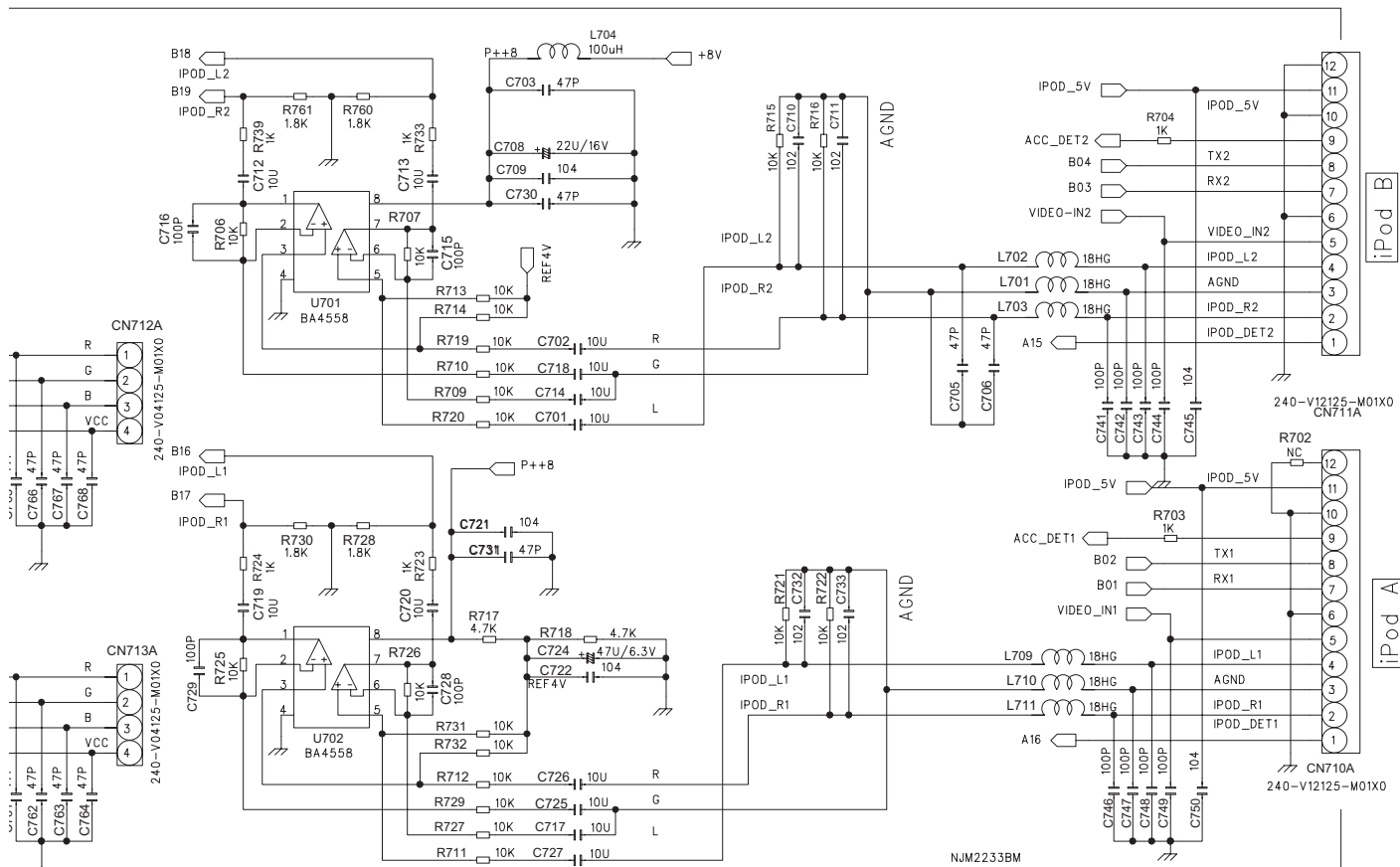




▲ Parts are safety assurance parts.  
When replacing those parts make  
sure to use the specified one.

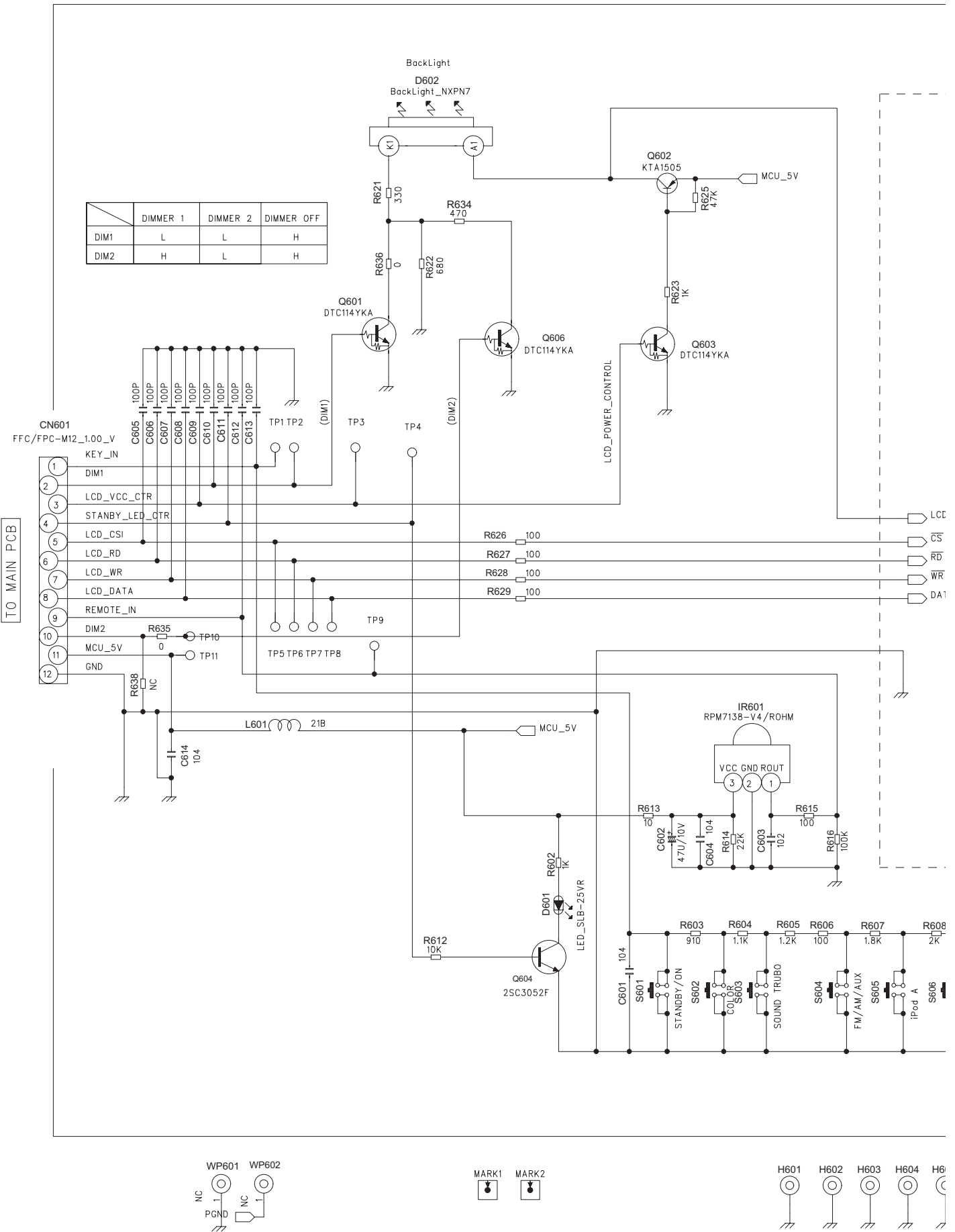


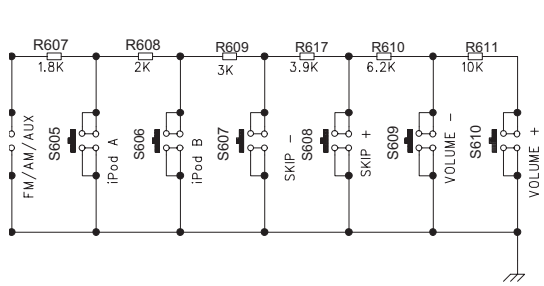
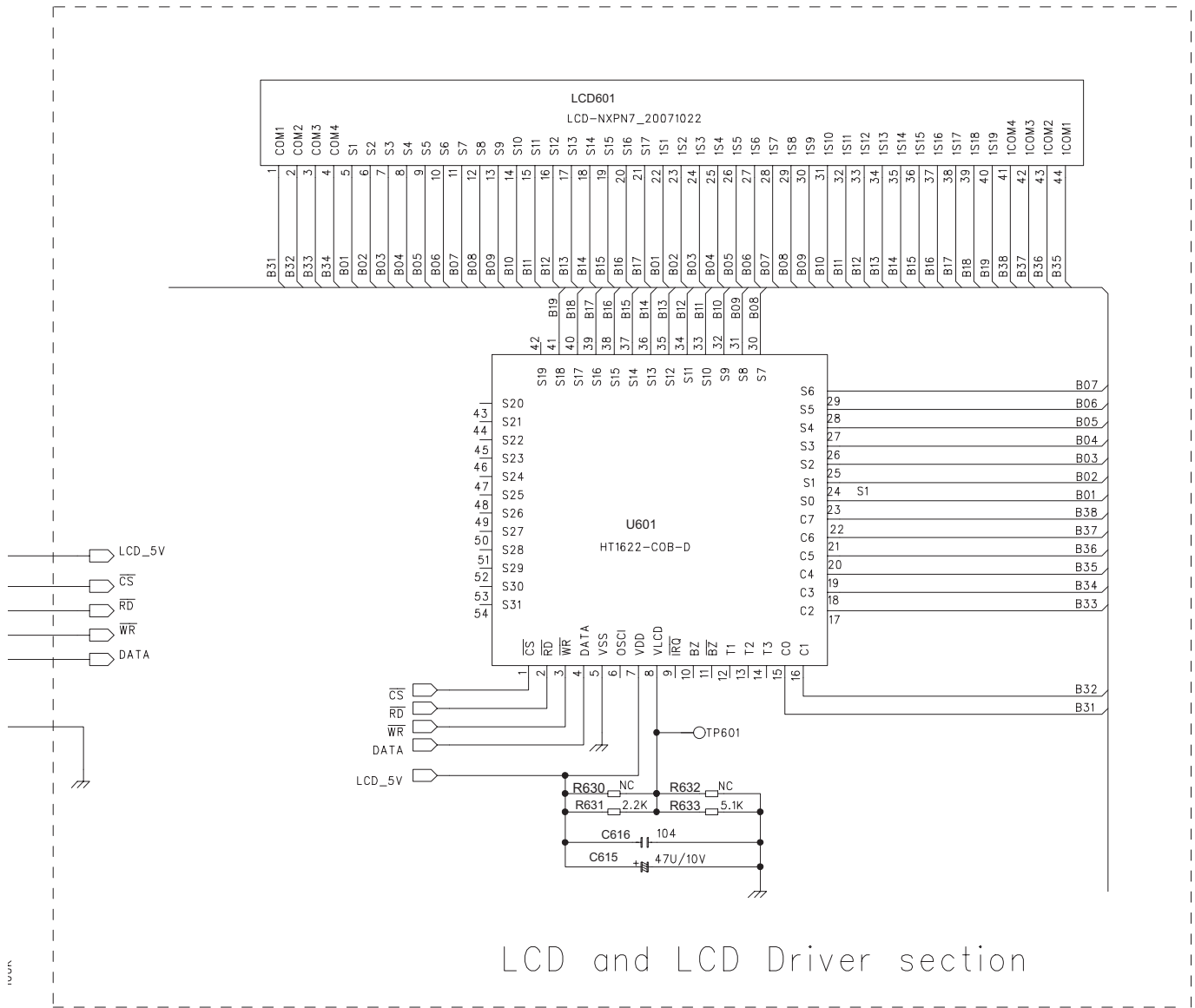




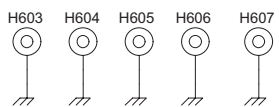
⚠ Parts are safety assurance parts. When replacing those parts make sure to use the specified one.

# Front section

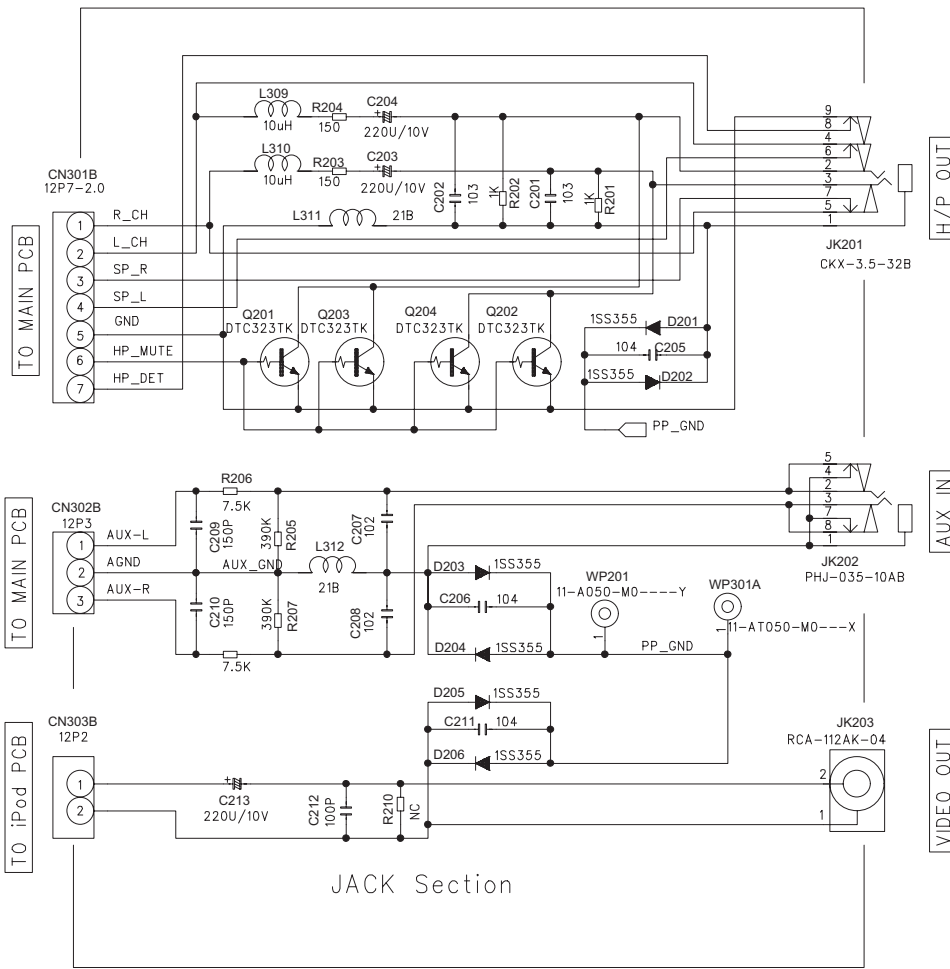




- MASK303 MASK
- MASK304 MASK
- MASK305 MASK
- MASK306 MASK
- MASK1 MASK
- MASK2 MASK
- MASK3 MASK
- MASK4 MASK

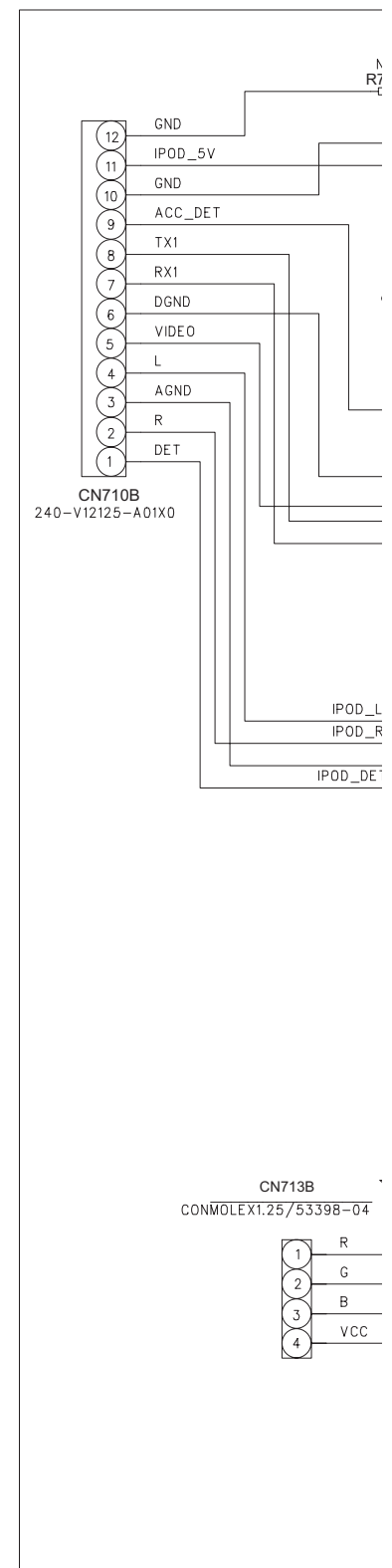


## Jack section

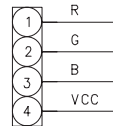


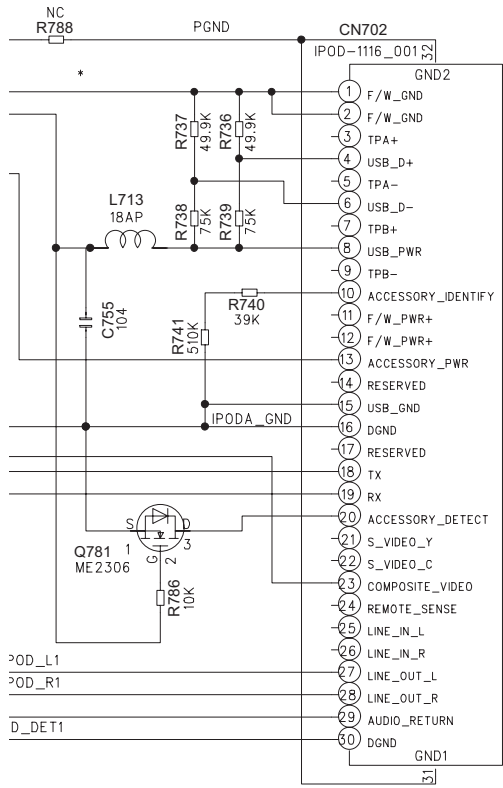
JACK Section

## iPod Stand section



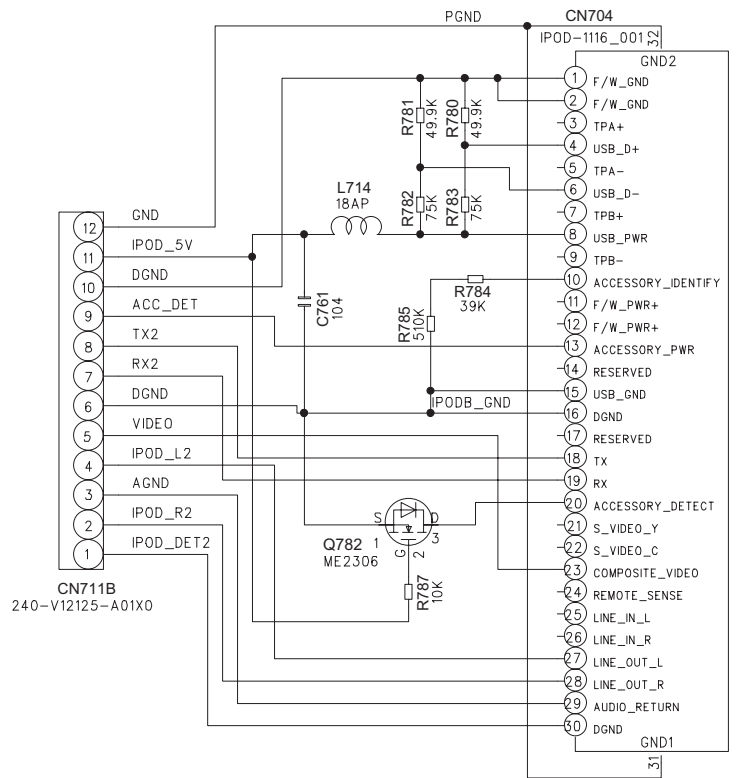
CN713B  
CONMOLEX1.25/53398-04





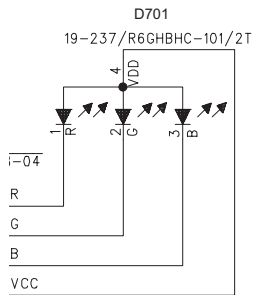
514S0117  
12S30-0024----X

IPOD A

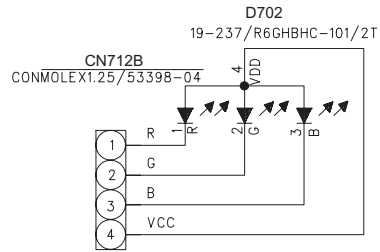


514S0117  
12S30-0024----X

IPOD B



LED A



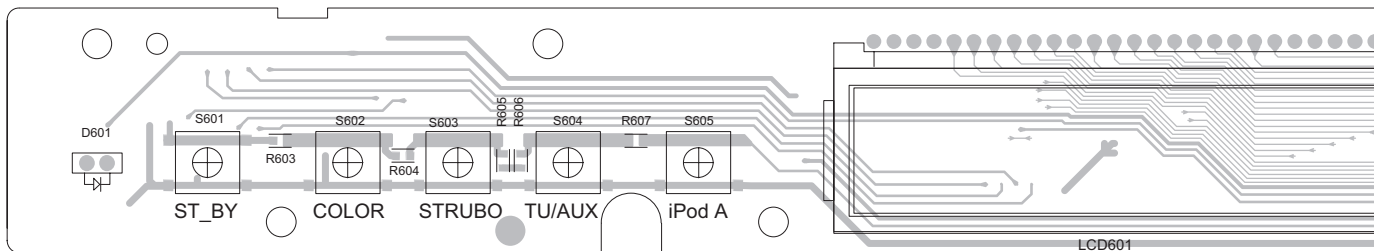
LED B

- MASK1 MASK
- MASK2 MASK
- MASK3 MASK
- MASK4 MASK
- MASK5 MASK
- MASK6 MASK
- MASK7 MASK
- MASK8 MASK

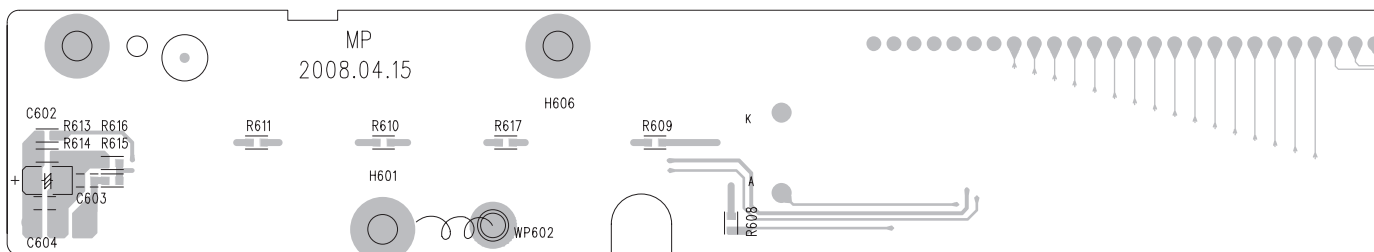
# Printed circuit boards

■ **Front board** Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade)

forward side

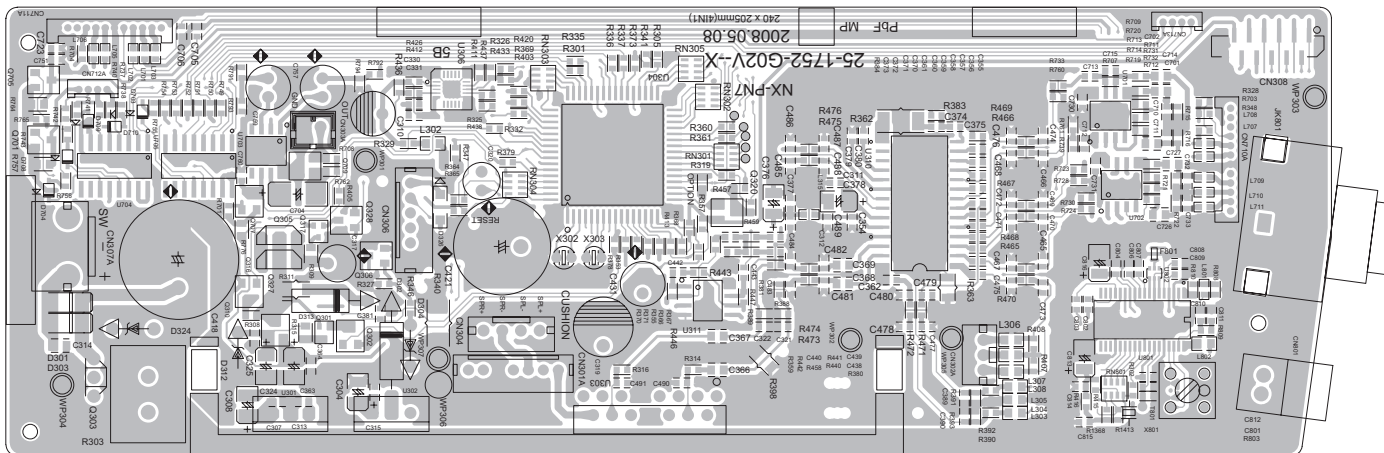


reverse side

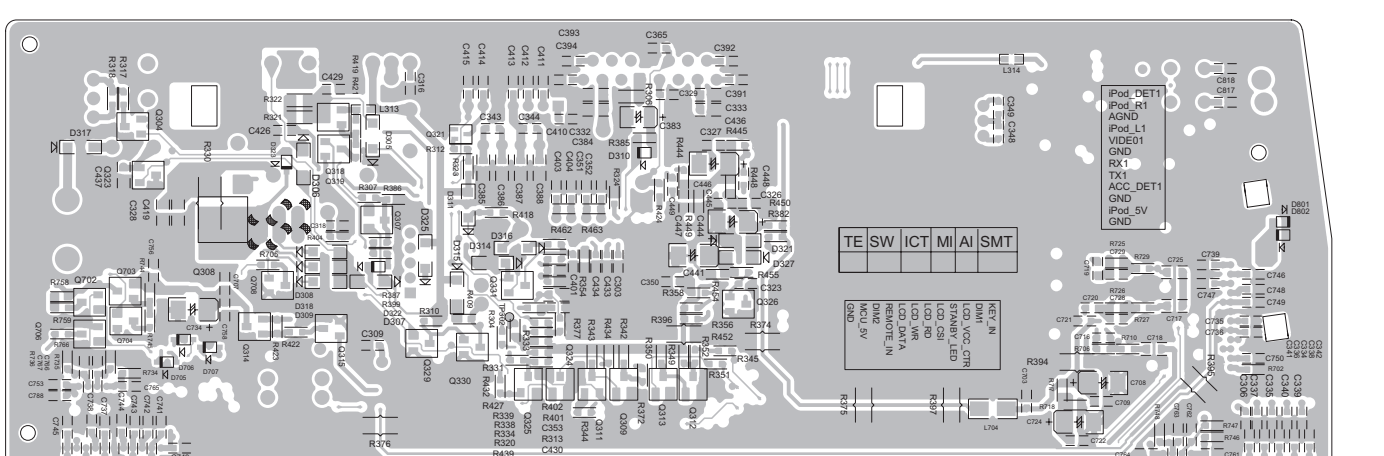


■ **Main board** Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade)

forward side

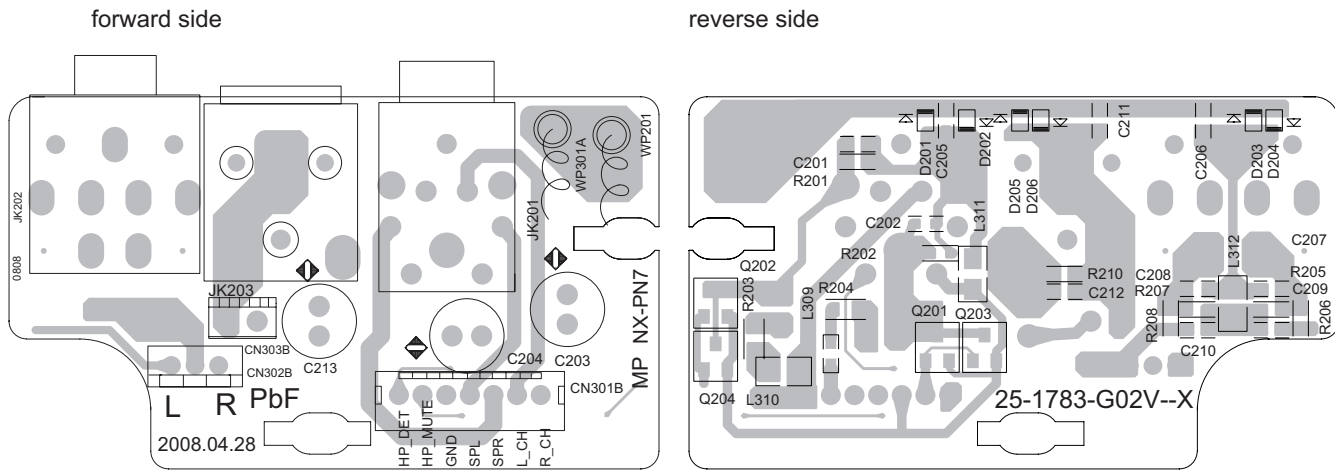


reverse side

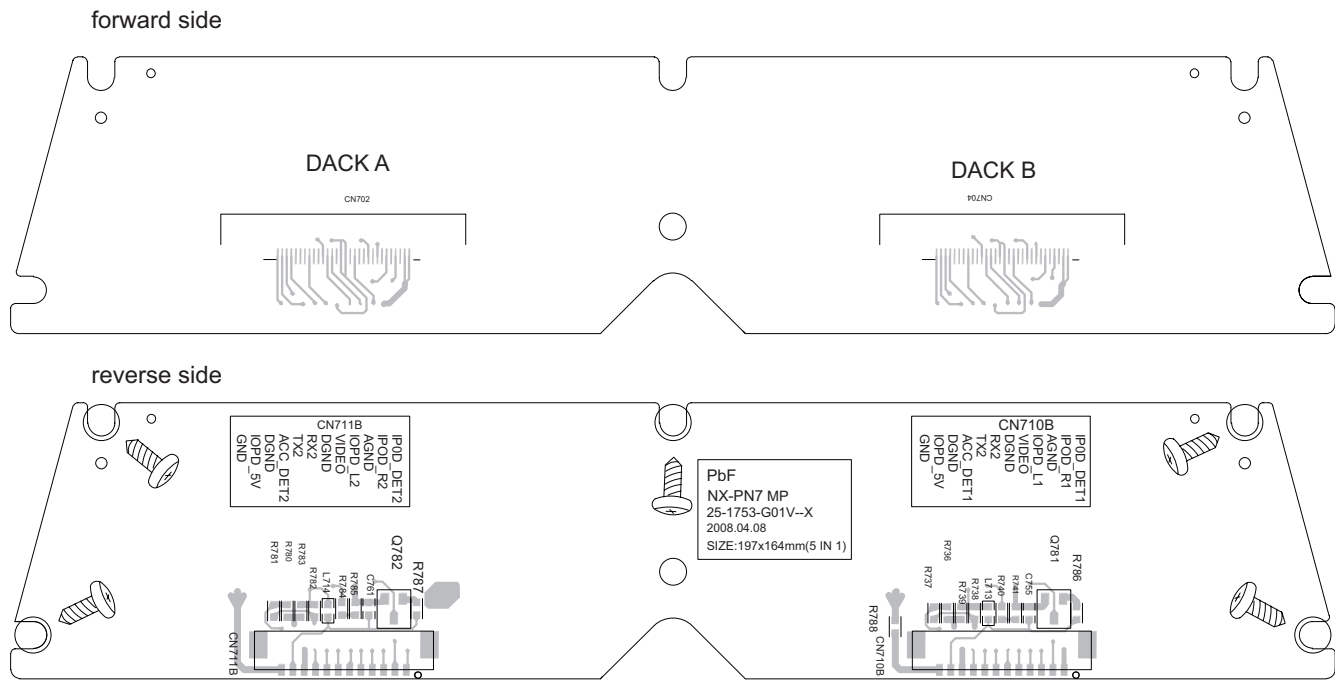




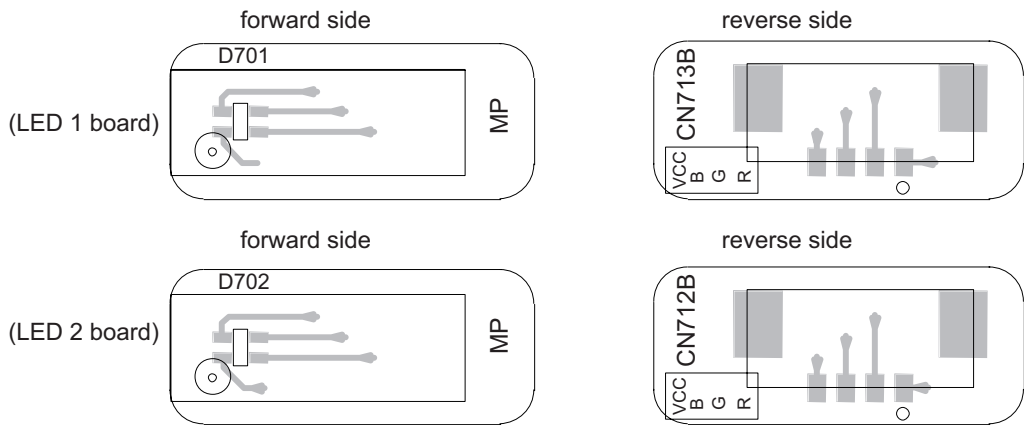
■ **Jack board** Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade)



■ **iPod board** Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade)



■ **LED board** Lead free solder used in the board (material : Sn-Ag-Cu, melting point : 219 Centigrade)





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